# 2.5V Drive Nch+Nch MOS FET

# EM6K1

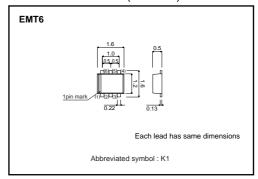
#### Structure

Silicon N-channel MOS FET

#### Features

- 1) Two 2SK3019 transistors in a single EMT package.
- 2) The MOS FET elements are independent, eliminating mutual interference.
- 3) Mounting cost and area can be cut in half.
- 4) Low on-resistance.
- 5) Low voltage drive (2.5V) makes this device ideal for portable equipment.

# ●External dimensions (Unit : mm)



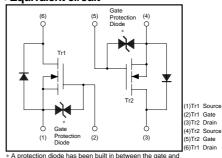
# Applications

Interfacing, switching (30V, 100mA)

## Packaging specifications

	Package	Taping
	Code	T2R
Туре	Basic ordering unit (pieces)	8000
EM6K1		0

# ●Equivalent circuit



A protection diode has been built in between the gate and
the source to protect against static electricity when the product
is in use. Use the protection circuit when rated voltages are exceeded

# ● Absolute maximum ratings (Ta=25°C)

<It is the same ratings for Tr1 and Tr2.>

Parameter		Symbol	Limits	Unit	
Drain-source voltage		Voss	30	V	
Gate-source voltage		Vgss	±20	V	
Drain current	Continuous	lo	±100	mA	
	Pulsed	IDP *1	±400	mA	
Total power dissipation		Pp*2	150	mW / TOTAL	
		PD	120	mW / ELEMENT	
Channel temperature		Tch	150	°C	
Storage temperature		Tstg	-55 to +150	°C	

<sup>\*1</sup> Pw≤10μs, Duty cycle≤1%

<sup>\*2</sup> With each pin mounted on the recommended lands.

### ●Electrical characteristics (Ta=25°C)

<It is the same characteristics for Tr1 and Tr2.>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	_	±1	μΑ	Vgs=±20V, Vps=0V
Drain-source breakdown voltage	V(BR)DSS	30	_	_	V	In=10μA, Vgs=0V
Zero gate voltage drain current	IDSS	_	_	1.0	μΑ	VDS=30V, VGS=0V
Gate threshold voltage	VGS(th)	0.8	_	1.5	V	Vps=3V, Ip=100μA
Static drain–source on–starte resistance	RDS(on)	_	5	8	Ω	In=10mA, Vgs=4V
	RDS(on)	_	7	13	Ω	In=1mA, Vgs=2.5V
Forward transfer admittance	Yfs	20	_	_	mS	Vps=3V, Ip=10mA
Input capacitance	Ciss	_	13	-	pF	V <sub>DS</sub> =5V
Output capacitance	Coss	_	9	_	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	_	4	_	pF	f=1MHz
Turn-on delay time	td(on)	_	15	-	ns	ID=10mA, VDD≒5V
Rise time	tr	_	35	-	ns	Vgs=5V
Turn-off delay time	td(off)	_	80	-	ns	RL=500Ω
Fall time	tf	_	80	_	ns	R <sub>G</sub> =10Ω

#### •Electrical characteristic curves

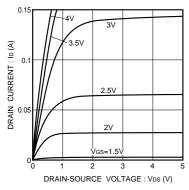


Fig.1 Typical Output Characteristics

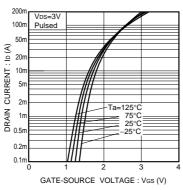


Fig.2 Typical Transfer Characteristics

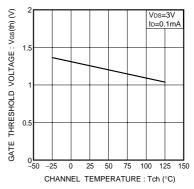


Fig.3 Gate Threshold Voltage vs. Channel Temperature

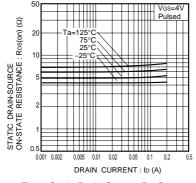


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (I)

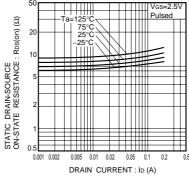


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current (II)

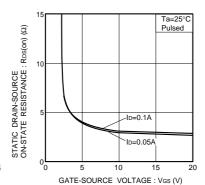


Fig.6 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

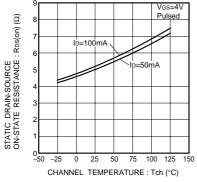


Fig.7 Static Drain-Source On-State Resistance vs. Channel Temperature

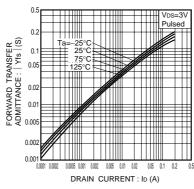


Fig.8 Forward Transfer Admittance vs. Drain Current

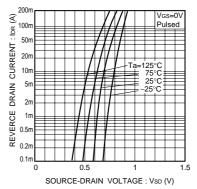


Fig.9 Reverse Drain Current vs. Source-Drain Voltage (I)

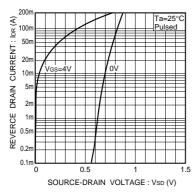


Fig.10 Reverse Drain Current vs. Source-Drain Voltage (II)

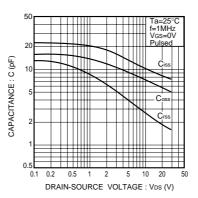


Fig.11 Typical Capacitance vs. Drain-Source Voltage

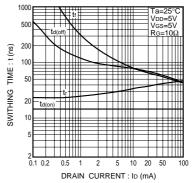


Fig.12 Switching Characteristics

#### Switching characteristics measurement circuits

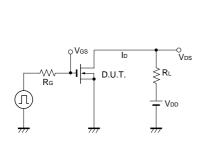


Fig.13 Switching Time Test Circuit

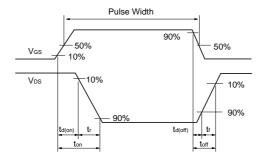


Fig.14 Switching Time Waveforms

## Notes

- No technical content pages of this document may be reproduced in any form or transmitted by any
  means without prior permission of ROHM CO.,LTD.
- The contents described herein are subject to change without notice. The specifications for the
  product described in this document are for reference only. Upon actual use, therefore, please request
  that specifications to be separately delivered.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or
  otherwise dispose of the same, no express or implied right or license to practice or commercially
  exploit any intellectual property rights or other proprietary rights owned or controlled by
- ROHM CO., LTD. is granted to any such buyer.
- Products listed in this document are no antiradiation design.

The products listed in this document are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).

Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

### About Export Control Order in Japan

Products described herein are the objects of controlled goods in Annex 1 (Item 16) of Export Trade Control Order in Japan.

In case of export from Japan, please confirm if it applies to "objective" criteria or an "informed" (by MITI clause) on the basis of "catch all controls for Non-Proliferation of Weapons of Mass Destruction.



# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ROHM Semiconductor: EM6K1T2R